



DATA SHEET

BAT54TW/ADW/CDW/SDW

SURFACE MOUNT SCHOTTKY DIODE ARRAYS

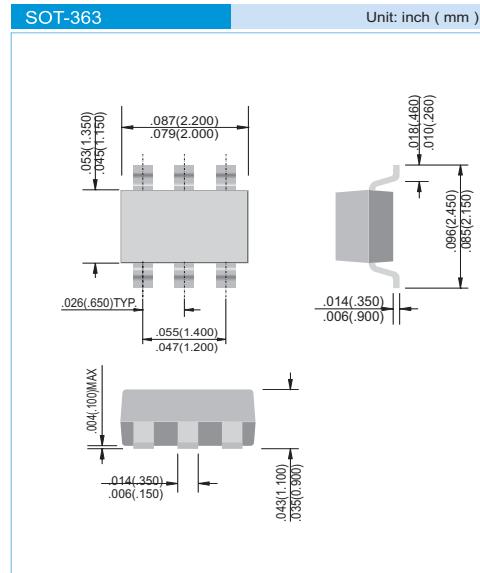
VOLTAGE 30 Volts **POWER** 200mWatts

FEATURES

Isolated diode arrays for significant board space savings
 Surface mount package ideally suited for automatic insertion
 Extremely Fast Switching Speed
 Very Low VF: 0.347V (Typ) at IF = 10mA
 Pb free product are available : 99% Sn above can meet RoHS environment substance directive request

MECHANICAL DATA

Case: SOT-363 plastic
 Terminals: Solderable per MIL-STD-202, Method
 Approx Weight: 0.008 gram
 Marking: BAT54TW: L4, BAT54ADW: L42,
 BAT54CDW: L43, BAT54SDW: L44



ABSOLUTE RATINGS (each diode)

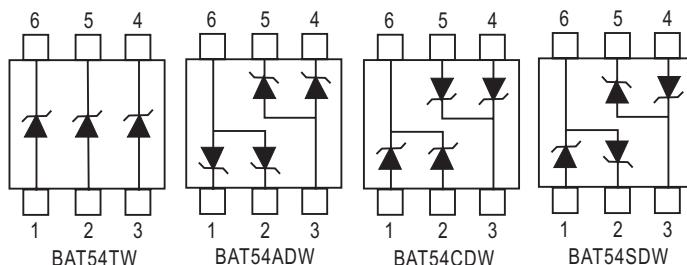
PARAMETER	Symbol	Value	Units
Maximum Reverse Voltage	V _R	30	V
Peak Reverse Voltage	V _{RRM}	30	V
Continuous Forward Current	I _F	0.2	A

THERMAL CHARACTERISTICS

PARAMETER	Symbol	Value	Units
Power Dissipation (Note 1)	P _{TO-T}	200	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{θJA}	625	°C/W
Junction Temperature	T _J	-55 to 125	°C
Storage Temperature	T _{STG}	-55 to 150	°C

NOTE:

1. FR-5 Board = 1.0 x 0.75 x 0.062 in.





ELECTRICAL CHARACTERISTICS (each diode) (TA=25°C, unless otherwise noted)

PARAMETER	Symbol	Test Condition	MIN.	TYP.	MAX.	Units
Reverse Breakdown Voltage	V_{BR}	$I=100 \mu A$	30			V
Reverse Current	I_R	$V_R=25 V$			2.0	μA
Forward Voltage	V_F	$I=0.1 m A$ $I=1.0 m A$ $I=10 m A$ $I=30 m A$ $I=100 m A$			0.24 0.32 0.40 0.50 1.0	V
Total Capacitance	C_T	$V_R=1 V, f=1.0 M Hz$			10	pF

ELECTRICAL CHARACTERISTICS CURVES

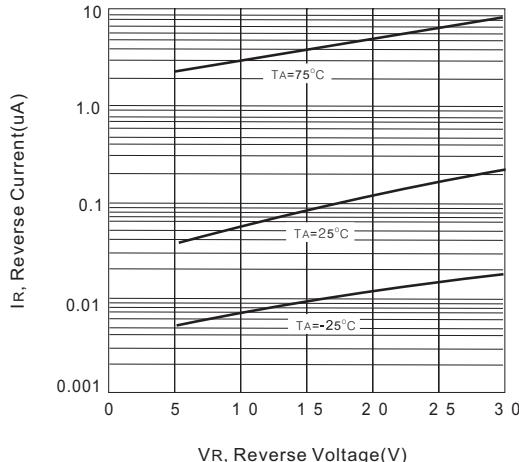


Fig. 1- Typical Reverse Leakage

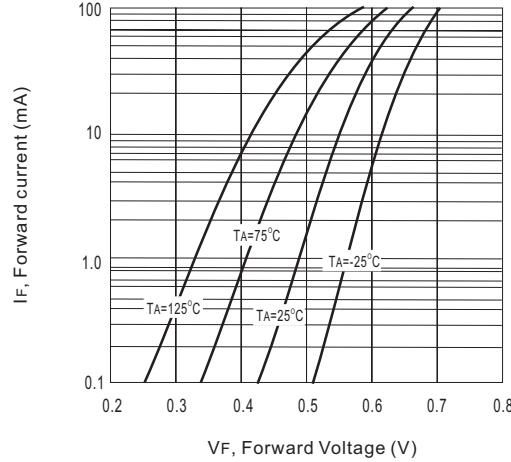


Fig. 2- Typical Forward Voltage

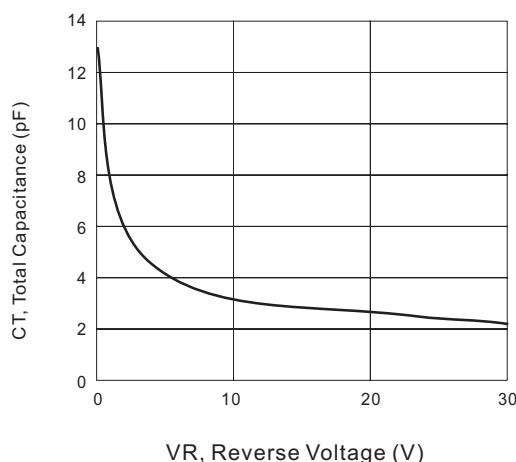


Fig. 3- Typical Total capacitance



ORDER INFORMATION

- Packing information

T/R - 12K per 13" plastic Reel

T/R - 3.0K per 7" plastic Reel

LEGAL STATEMENT

IMPORTANT NOTICE

This information is intended to unambiguously characterize the product in order to facilitate the customer's evaluation of the device in the application. The information will help the customer's technical experts determine that the device is compatible and interchangeable with similar devices made by other vendors. The information in this data sheet is believed to be reliable and accurate. The specifications and information herein are subject to change without notice. New products and improvements in products and product characterization are constantly in process. Therefore, the factory should be consulted for the most recent information and for any special characteristics not described or specified.

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